Tyrone Camarero Specifications

Camarero DS300TT-12

Key features

Two systems (nodes) in a 1U form factor. Each node supports the following:

- Dual socket R3 (LGA 2011) supports Intel® Xeon® processor E5-2600 v4/ v3 family
- Intel® C612 chipset
- Up to 1TB ECC 3DS LRDIMM, up to DDR4- 2400 MHz; 8x DIMM slots
- 1x PCI-E 3.0 x16 (in x16) slot
- 2x 3.5" Hot-swap SAS/SATA drive bays
- Intel® i350 Dual port GbE LAN
- I/O ports: 2x SuperDOM, 1x VGA, 1x COM, 2x USB 2.0 (rear)
- 1000W High-efficiency Power Supply Titanium Level Certified





Processor/Cache

Processor Dual socket R3 (LGA 2011) supports Intel®

Xeon® processor E5-2600 v4/ v3 family

Chipset

Chipset Intel® C612 chipset

System Memory

Memory Capacity 8x 288-pin DDR4 DIMM slots, Up to 1TB

ECC 3DS LRDIMM, 256 ECC RDIMM

Expansion Slots

1x PCI-E 3.0 x16 (in x16) slot

Integrated On-Board

SATA SATA3 (6Gbps); RAID 0, 1, 5, 10

LAN 2x RJ45 Gigabit Ethernet LAN ports,

1x RJ45 Dedicated IPMI LAN port

Add-on Options

Raid Optional

Optical drive None

Front Panel

LED Indicators Power status LED, HDD activity LED,

2x Network activity LEDs, Universal

Information (UID) LED

Buttons Power On/Off button, System Reset button,

UID button

Drive Bays

HDD Bays 2x 3.5" Hot-swap drive bays

Power Supply

1000W High-efficiency Power Supply Titanium Level Certified

Cooling System

3x 40x56mm counter-rotation PWM fans

Form Factor

Form Factor 1U Twin

Width: 17.2" (437mm), Height: 1.75" (44.45mm), Depth: 27.75" (705mm)

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For more/current product information, visit www.tyronesystems.com

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